## **IN THE CLAIMS**:

- 1. (Currently Amended) A curable silicone composition comprising:
- (A) an organopolysiloxane represented by the siloxane unit formula (1) given below and having at least two univalent organic groups that contain epoxy groups and are free of aromatic rings:

$$[R^{1}_{3}SiO_{1/2}]_{a}[R^{2}_{2}SiO_{2/2}]_{b}[R^{3}SiO_{3/2}]_{c}$$
 (1)

where  $R^1$ ,  $R^2$ , and  $R^3$  are univalent organic groups, at least two of which are univalent organic groups which contain epoxy groups and are free of aromatic rings; more than 20 mole % of  $R^3$  are aryl groups; a + b + c = 1; on average, "a" satisfies the following condition:  $0 \le a \le 0.8$ ; on average, "b" satisfies the following condition:  $0 \le b \le 0.8$ ; and, on average, "c" satisfies the following condition:  $0.2 \le c \le 1.0$ ;

(B) a linear-chain organopolysiloxane having at least two univalent organic groups that contain phenolic hydroxyl groups, where said linear-chain organopolysiloxane is represented by the following formula (2):

R73SiO(R82SiO)mSiR73 (2)

where R7 and R8 may be the same or different and represent univalent organic groups of which, at least two are univalent organic groups having phenolic hydroxyl groups; and "m" is an integer having a value of 0 to 1000 an

$$Z-(CH_3)_2SiO(CH_3)_2Si-Z$$
 (4)

where Z is 3-(m-hydroxyphenyl)propyl group; and

organopolysiloxane represented by the following formula (4):

- (C) a curing accelerator.
- 2. (Original) The curable silicone composition of Claim 1, further comprising a filler (D).
- 3. (Previously Presented) The curable silicone composition of Claim 1, where component (A) is liquid.
- 4. (Previously Presented) The curable silicone composition of Claim 1, where in the siloxane unit formula (1),  $0 < a \le 0.8$ ; and b=0.
- 5. (Cancelled).
- 6. (Cancelled).
- 7. (Previously Presented) The curable silicone composition of Claim 1, where component (B) is used in an amount of 1 to 1000 parts by weight, and component (C) in an amount of 0.01 to 100 parts by weight for each 100 parts by weight of component (A).
- 8. (Previously Presented) The curable silicone composition of Claim 1, where the epoxy group of component (A) is a glycidoxy group or a 2,4-epoxycyclohexyl group.
- 9. (Previously Presented) The curable silicone composition of Claim 1, which is in a liquid or a paste-like form.
- 10. (Previously Presented) A cured product obtained by curing the curable silicone composition according to Claim 1.
- 11. (Cancelled).

- 12. (Previously Presented) The curable silicone composition of Claim 2, where component (A) is liquid.
- 13. (Previously Presented) The curable silicone composition of Claim 2, where in the siloxane unit formula (1),  $0 < a \le 0.8$ ; and b=0.
- 14. (Cancelled).
- 15. (Cancelled).
- 16. (Previously Presented) The curable silicone composition of Claim 2, where component (B) is used in an amount of 1 to 1000 parts by weight, and component (C) in an amount of 0.01 to 100 parts by weight for each 100 parts by weight of component (A).
- 17. (Previously Presented) The curable silicone composition of Claim 2, where the epoxy group of component (A) is a glycidoxy group or a 2,4-epoxycyclohexyl group.
- 18. (Previously Presented) The curable silicone composition of Claim 2, which is in a liquid or a paste-like form.